

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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Small Signal MOSFET

-20 V, -430 mA, Dual P-Channel with ESD Protection, SOT-563

Features

- Low R_{DS(on)} Improving System Efficiency
- Low Threshold Voltage
- ESD Protected Gate
- Small Footprint 1.6 x 1.6 mm
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Load/Power Switches
- Power Supply Converter Circuits
- Battery Management
- Cell Phones, Digital Cameras, PDAs, Pagers, etc.

MAXIMUM RATINGS ($T_J = 25^{\circ}C$ unless otherwise noted.)

Parame	Symbol	Value	Unit				
Drain-to-Source Voltage			V _{DSS}	-20	V		
Gate-to-Source Voltage			V _{GS}	±6.0	V		
Continuous Drain Current	I Sleauv I A		l-	-430	mA		
(Note 1)	State	$T_A = 85^{\circ}C$	I _D	-310			
Power Dissipation (Note 1)	Steady State		Steady State		P _D	250	mW
Continuous Drain Current		$T_A = 25^{\circ}C$	l-	-455	mA		
(Note 1)	te 1) $t \le 5 s T_A = T_$		I _D	-328			
Power Dissipation (Note 1)	t ≤ 5 s		P _D	280	mW		
Pulsed Drain Current	t _p =	:10 μs	I _{DM}	-750	mA		
Operating Junction and Sto	T _J , T _{STG}	–55 to 150	°C				
Source Current (Body Diod	I _S	-350	mA				
Lead Temperature for Sold (1/8" from case for 10 s	TL	260	°C				

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Unit
Junction-to-Ambient - Steady State (Note 1)		500	°C/W
Junction–to–Ambient – $t \le 5$ s (Note 1)	$R_{\theta JA}$	447	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

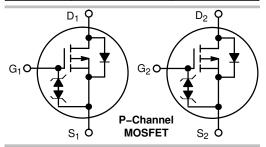
1. Surface mounted on FR4 board using 1 in. sq. pad size (Cu. area = 1.127 in. sq. [1 oz.] including traces).



ON Semiconductor®

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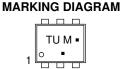
V _{(BR)DSS}	R _{DS(on)} Typ	I _D Max	
	0.5 Ω @ -4.5 V		
–20 V	0.6 Ω @ -2.5 V	–430 mA	
	1.0 Ω @ –1.8 V		



6

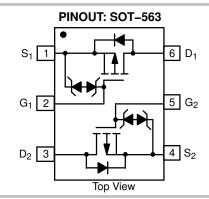
CASE 463A

SOT-563-6



TU = Specific Device Code M = Date Code

■ = Pb-Free Package (Note: Microdot may be in either location)



ORDERING INFORMATION

Device	Package	Shipping [†]
NTZD3152PT1G	SOT-563	4000 / Tana 8 Daal
NTZD3152PT1H	(Pb-Free)	4000 / Tape & Reel
NTZD3152PT5H	SOT-563	8000 / Tape & Reel
	(Pb-Free)	0000 / Tape & neel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted.)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS							•
Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		-20			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				18		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = -16 V	$T_J = 25^{\circ}C$			-1.0	μА
			T _J = 125°C			-2.0	
Gate-to-Source Leakage Current	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS}$	s = ±4.5 V			±2.0	μΑ
ON CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{D}$	= -250 μA	-0.45		-1.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-1.9		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	$V_{GS} = -4.5 \text{ V}, I_{E}$	₀ = -430 mA		0.5	0.9	Ω
		$V_{GS} = -2.5 \text{ V}, I_{E}$	₀ = -300 mA		0.6	1.2	1
		$V_{GS} = -1.8 \text{ V}, I_D = -150 \text{ mA}$			1.0	2.0	1
Forward Transconductance	9FS	$V_{DS} = -10 \text{ V}, I_D = -430 \text{ mA}$			1.0		S
CHARGES AND CAPACITANCES							•
Input Capacitance	C _{ISS}				105	175	pF
Output Capacitance	C _{OSS}	$V_{GS} = 0 \text{ V, f} = 1.0 \text{ MHz,}$ $V_{DS} = -16 \text{ V}$			15	30	1
Reverse Transfer Capacitance	C _{RSS}	V DS = −	10 V		10	20	1
Total Gate Charge	Q _{G(TOT)}				1.7	2.5	nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = -4.5 V, V	nc = -10 V		0.1		
Gate-to-Source Charge	Q _{GS}	I _D = -21	5 mA		0.3		1
Gate-to-Drain Charge	Q _{GD}				0.4		
SWITCHING CHARACTERISTICS (Not	e 3)					•	•
Turn-On Delay Time	t _{d(on)}				10		ns
Rise Time	t _r	Voc = -4.5 V. V	nn = -10 V		12		
Turn-Off Delay Time	t _{d(off)}	$V_{GS} = -4.5 \text{ V}, V_{DD} = -10 \text{ V},$ $I_D = -215 \text{ mA}, R_G = 10 \Omega$			35		
Fall Time	t _f				19		
DRAIN-SOURCE DIODE CHARACTER	RISTICS					-	-
Forward Diode Voltage	V_{SD}	$V_{GS} = 0 \text{ V},$ $I_{S} = -350 \text{ mA}$	T _J = 25°C		-0.8	-1.2	V
Reverse Recovery Time	t _{RR}	$V_{GS} = 0 \text{ V, } dI_{SD}/dt = 100 \text{ A/}\mu\text{s,}$ $I_{S} = -350 \text{ mA}$			13		ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Pulse Test: pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$.

3. Switching characteristics are independent of operating junction temperatures.

TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

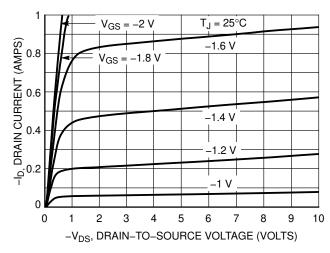


Figure 1. On-Region Characteristics

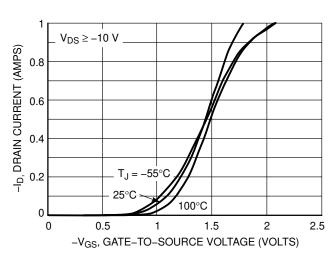


Figure 2. Transfer Characteristics

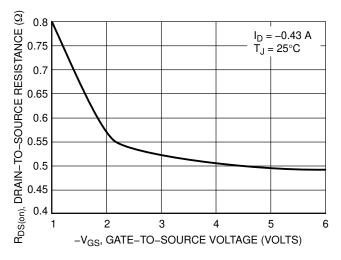


Figure 3. On-Resistance vs. Gate-to-Source Voltage

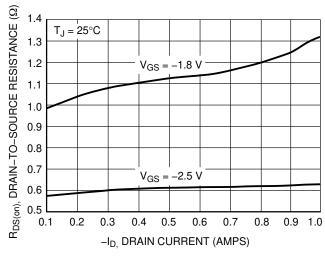


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

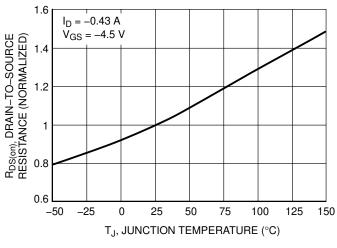


Figure 5. On–Resistance Variation with Temperature

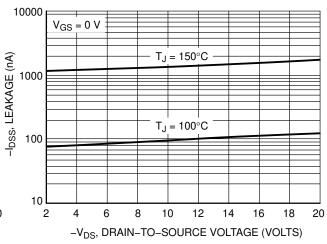


Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL PERFORMANCE CURVES (T_J = 25°C unless otherwise noted)

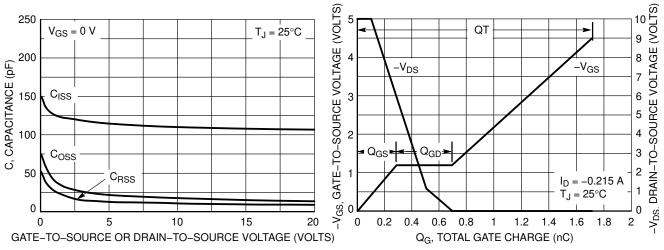


Figure 7. Capacitance Variation

Figure 8. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge

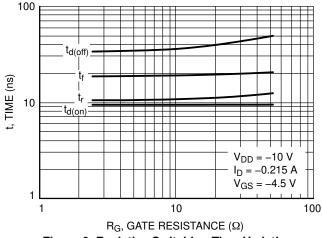


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

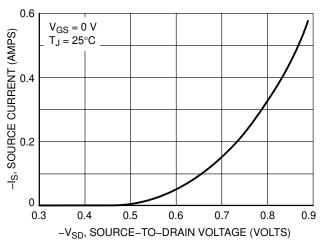


Figure 10. Diode Forward Voltage vs. Current

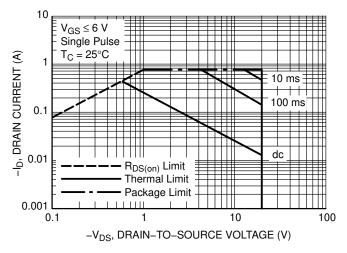
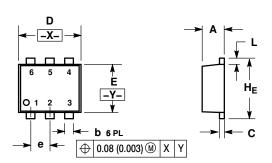


Figure 11. Safe Operating Area

PACKAGE DIMENSIONS

SOT-563, 6 LEAD CASE 463A ISSUE G

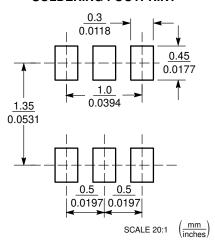


NOTES

- DIMENSIONING AND TOLERANCING PER ANSI
 V14 5M 1982
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL

	MILLIMETERS			INCHES			
DIM	MIN	NOM	MAX	MIN	NOM	MAX	
Α	0.50	0.55	0.60	0.020	0.021	0.023	
b	0.17	0.22	0.27	0.007	0.009	0.011	
O	0.08	0.12	0.18	0.003	0.005	0.007	
D	1.50	1.60	1.70	0.059	0.062	0.066	
Е	1.10	1.20	1.30	0.043	0.047	0.051	
е	0.5 BSC			(0.02 BSC		
L	0.10	0.20	0.30	0.004	0.008	0.012	
He	1.50	1.60	1.70	0.059	0.062	0.066	

SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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